

SN54AS286, SN74AS286 9-BIT PARITY GENERATORS/CHECKERS WITH BUS-DRIVER PARITY I/O PORT

SDAS050B – DECEMBER 1983 – REVISED DECEMBER 1994

- Generate Either Odd or Even Parity for Nine Data Lines
- Cascadable for n-Bit Parity
- Direct Bus Connection for Parity Generation or Checking by Using the Parity I/O Port
- Glitch-Free Bus During Power Up/Down
- Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

description

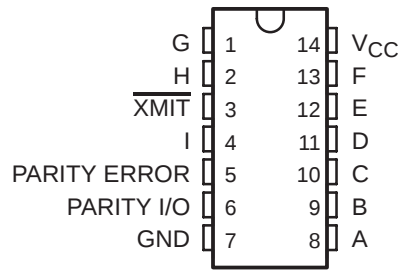
The SN54AS286 and SN74AS286 universal 9-bit parity generators/checkers feature a local output for parity checking and a 48-mA bus-driving parity input/output (I/O) port for parity generation/checking. The word-length capability is easily expanded by cascading.

The transmit ($\overline{\text{XMIT}}$) control input is implemented specifically to accommodate cascading. When $\overline{\text{XMIT}}$ is low, the parity tree is disabled and PARITY ERROR remains at a high logic level regardless of the input levels. When $\overline{\text{XMIT}}$ is high, the parity tree is enabled. PARITY ERROR indicates a parity error when either an even number of inputs (A–I) are high and PARITY I/O is forced to a low logic level, or when an odd number of inputs are high and PARITY I/O is forced to a high logic level.

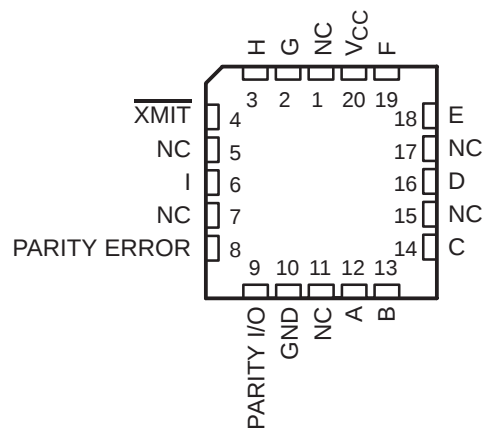
The I/O control circuitry was designed so that the I/O port remains in the high-impedance state during power up or power down to prevent bus glitches.

The SN54AS286 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74AS286 is characterized for operation from 0°C to 70°C .

SN54AS286 . . . J PACKAGE
SN74AS286 . . . D OR N PACKAGE
(TOP VIEW)



SN54AS286 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

FUNCTION TABLE

NUMBER OF INPUTS (A–I) THAT ARE HIGH	$\overline{\text{XMIT}}$	PARITY I/O	PARITY ERROR
0, 2, 4, 6, 8	L	H	H
1, 3, 5, 7, 9	L	L	H
0, 2, 4, 6, 8	h	h	H
	h	L	L
1, 3, 5, 7, 9	h	h	L
	h	L	H

h = high input level
H = high output level

L = low input level
L = low output level

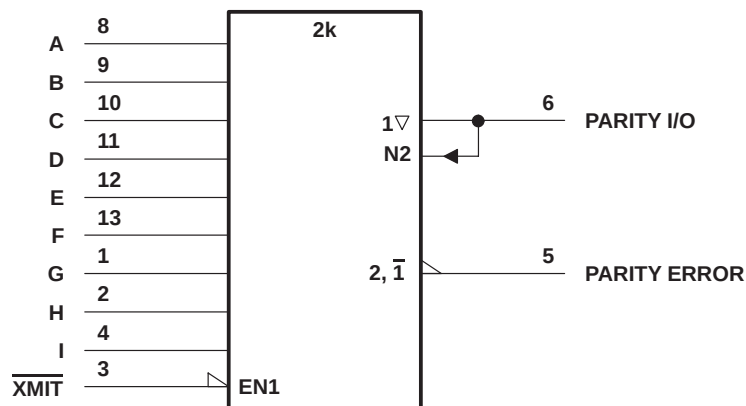
SN54AS286, SN74AS286

9-BIT PARITY GENERATORS/CHECKERS

WITH BUS-DRIVER PARITY I/O PORT

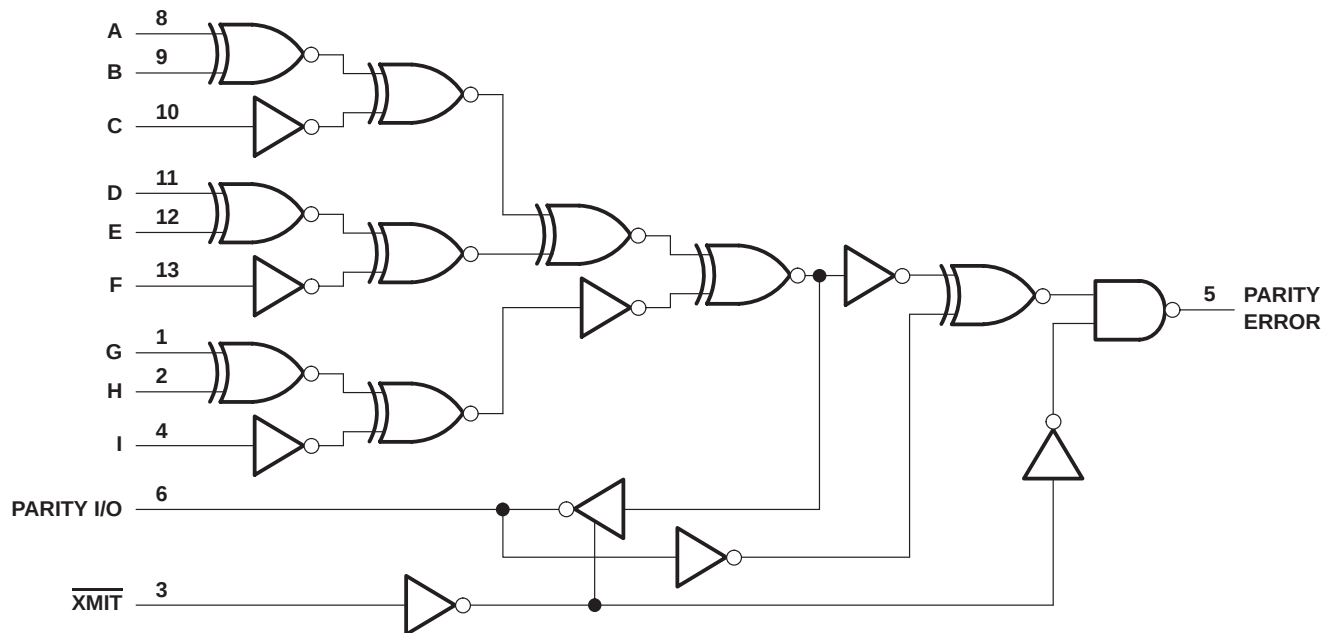
SDAS050B - DECEMBER 1983 - REVISED DECEMBER 1994

logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for the D, J, and N packages.

logic diagram (positive logic)



Pin numbers shown are for the D, J, and N packages.

SN54AS286, SN74AS286
9-BIT PARITY GENERATORS/CHECKERS
WITH BUS-DRIVER PARITY I/O PORT
SDAS050B – DECEMBER 1983 – REVISED DECEMBER 1994

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage, V_{CC}	7 V
Input voltage, V_I	7 V
Voltage applied to a disabled 3-state output	5.5 V
Operating free-air temperature range, T_A : SN54AS286	–55°C to 125°C
SN74AS286	0°C to 70°C
Storage temperature range	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

			SN54AS286			SN74AS286			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC}	Supply voltage		4.5	5	5.5	4.5	5	5.5	V
V _{IH}	High-level input voltage		2			2			V
V _{IL}	Low-level input voltage				0.8			0.8	V
I _{OH}	High-level output current	PARITY ERROR	−2			−2			mA
		PARITY I/O	−12			−15			
I _{OL}	Low-level output current	PARITY ERROR	20			20			mA
		PARITY I/O	32			48			
T _A	Operating free-air temperature		−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		SN54AS286			SN74AS286			UNIT
				MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V _{IK}		V _{CC} = 4.5 V,	I _I = −18 mA	−1.2			−1.2			V
V _{OH}	All outputs	V _{CC} = 4.5 V to 5.5 V,	I _{OH} = −2 mA	V _{CC} − 2			V _{CC} − 2			V
	PARITY I/O	V _{CC} = 4.5 V	I _{OH} = −3 mA	2.4	2.9		2.4	3		
			I _{OH} = −12 mA	2.4						
			I _{OH} = −15 mA				2.4			
V _{OL}	PARITY ERROR	V _{CC} = 4.5 V	I _{OL} = 20 mA	0.35	0.5		0.35	0.5	V	
	PARITY I/O		I _{OL} = 32 mA	0.5						
			I _{OL} = 48 mA			0.5				
I _I	PARITY I/O	V _{CC} = 5.5 V	V _I = 5.5 V	0.1			0.1			mA
	All other inputs		V _I = 7 V	0.1			0.1			
I _{IH}	PARITY I/O [§]	V _{CC} = 5.5 V,	V _I = 2.7 V	50			50			μA
	All other inputs			20			20			
I _{IL}	PARITY I/O [§]	V _{CC} = 5.5 V,	V _I = 0.4 V	−0.5			−0.5			mA
	All other inputs			−0.5			−0.5			
I _O [¶]		V _{CC} = 5.5 V,	V _O = 2.25 V	−30	−112		−30	−112		mA
I _{CC}	Transmit	V _{CC} = 5.5 V		30	43		30	43		mA
	Receive			35	50		35	50		

[‡] All typical values are at $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$.

[§] For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current.

^{||} The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS} .



SN54AS286, SN74AS286

9-BIT PARITY GENERATORS/CHECKERS

WITH BUS-DRIVER PARITY I/O PORT

SDAS050B – DECEMBER 1983 – REVISED DECEMBER 1994

switching characteristics (see Figure 3)

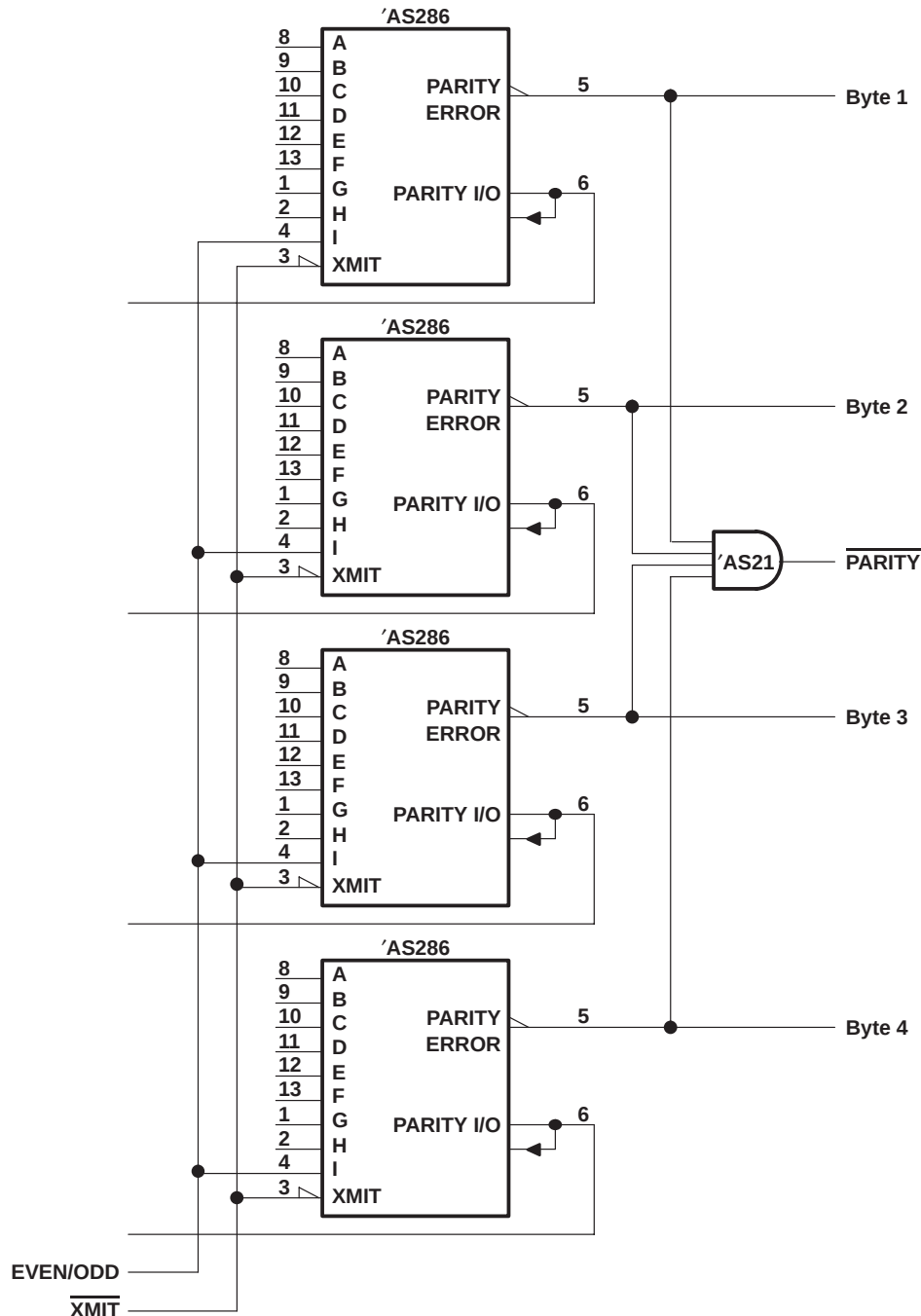
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 4.5 V to 5.5 V, C _L = 50 pF, R ₁ = 500 Ω, R ₂ = 500 Ω, T _A = MIN to MAX†				UNIT
			SN54AS286		SN74AS286		
			MIN	MAX	MIN	MAX	
t _{PLH}	Any A – I	PARITY I/O	3	17	3	15	ns
t _{PHL}			3	15	3	14	
t _{PLH}	Any A – I	PARITY ERROR	3	20	3	16.5	ns
t _{PHL}			3	18	3	16.5	
t _{PLH}	PARITY I/O	PARITY ERROR	3	10	3	9	ns
t _{PHL}			3	10	3	9	
t _{PZH}	$\overline{\text{XMIT}}$	PARITY I/O	3	14	3	13	ns
t _{PZL}			3	17	3	16	
t _{PHZ}	$\overline{\text{XMIT}}$	PARITY I/O	3	13	3	11.5	ns
t _{PLZ}			3	11	3	10	

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



APPLICATION INFORMATION

Figure 1 shows a 32-bit parity generator/checker with output polarity switching, parity-error detection, and parity on every byte.



Pin numbers shown are for the D, J, and N packages.

Figure 1. 32-Bit Parity Generator/Checker

SN54AS286, SN74AS286

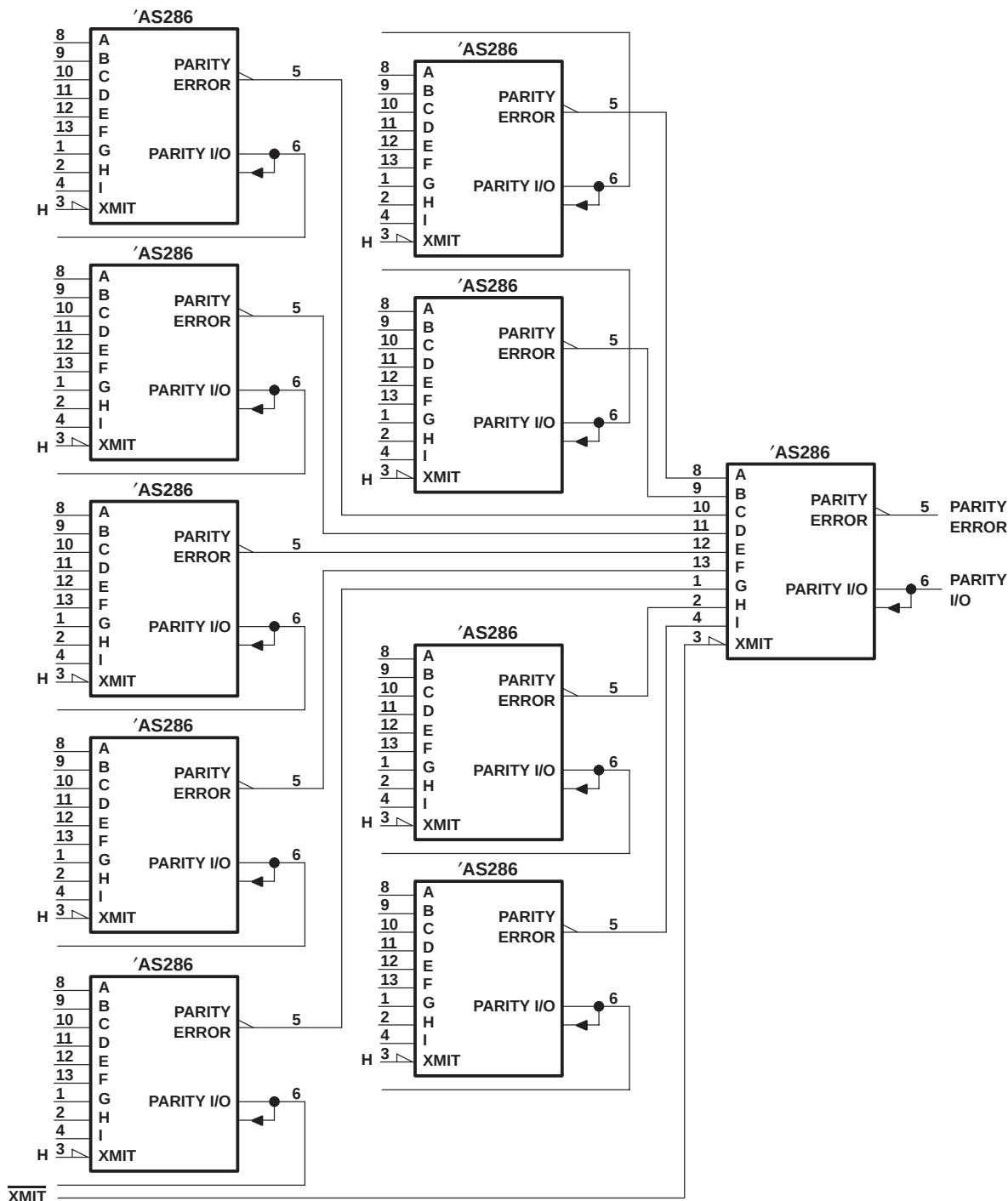
9-BIT PARITY GENERATORS/CHECKERS

WITH BUS-DRIVER PARITY I/O PORT

SDAS050B - DECEMBER 1983 - REVISED DECEMBER 1994

APPLICATION INFORMATION

Figure 2 shows a 90-bit parity generator/checker with $\overline{\text{XMIT}}$ on the last stage available for use with parity detection.



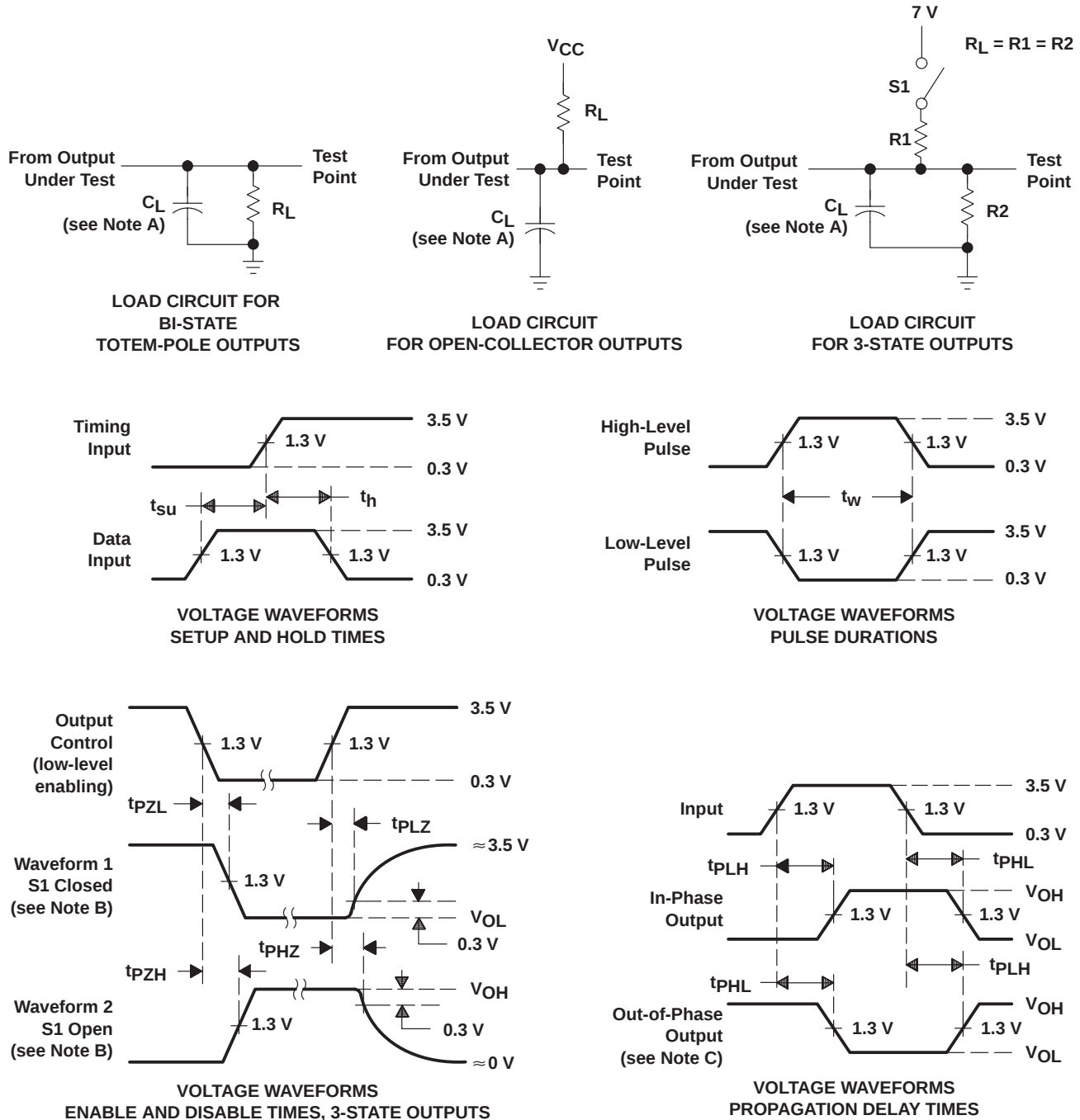
Pin numbers shown are for the D, J, and N packages.

Figure 2. 90-Bit Parity Generator/Checker With Parity-Error Detection



POST OFFICE BOX 655303 • DALLAS, TEXAS 75265
POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



- NOTES: A. C_L includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
D. All input pulses have the following characteristics: $PRR \leq 1$ MHz, $t_r = t_f = 2$ ns, duty cycle = 50%.
E. The outputs are measured one at a time with one transition per measurement.

Figure 3. Load Circuits and Voltage Waveforms

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
SN74AS286D	Active	Production	SOIC (D) 14	50 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	AS286

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "--" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
SN74AS286D	D	SOIC	14	50	506.6	8	3940	4.32

D0014A**PACKAGE OUTLINE****SOIC - 1.75 mm max height**

SMALL OUTLINE INTEGRATED CIRCUIT



4220718/A 09/2016

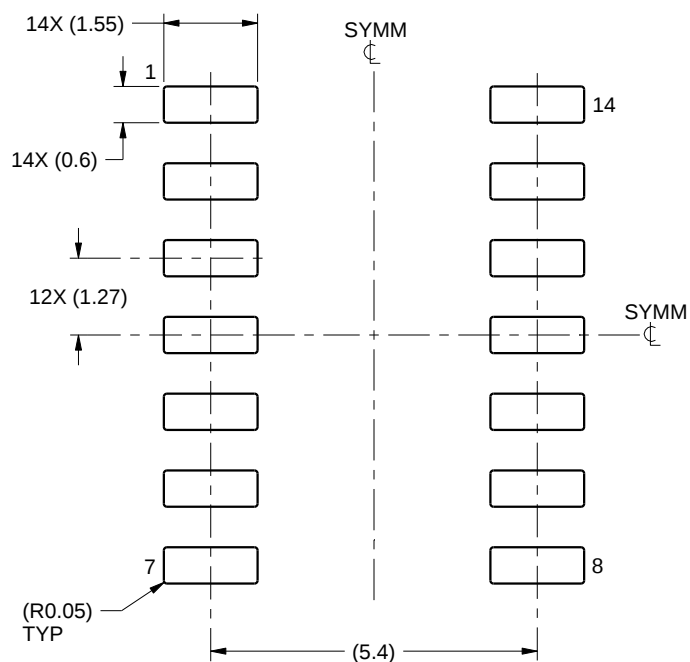
NOTES:

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm, per side.
5. Reference JEDEC registration MS-012, variation AB.

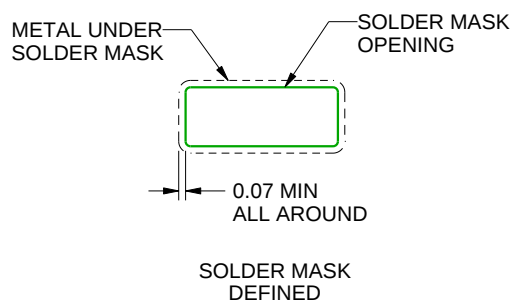
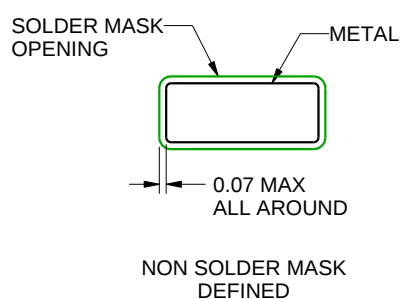
D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE
SCALE:8X



SOLDER MASK DETAILS

4220718/A 09/2016

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

D0014A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:8X

4220718/A 09/2016

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to [TI's Terms of Sale](#) or other applicable terms available either on [ti.com](https://www.ti.com) or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2025, Texas Instruments Incorporated